

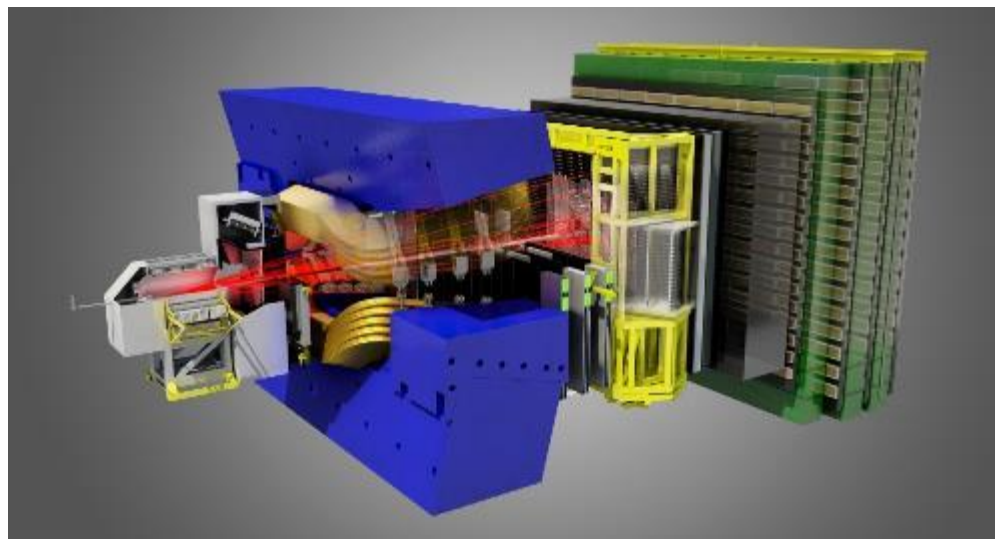
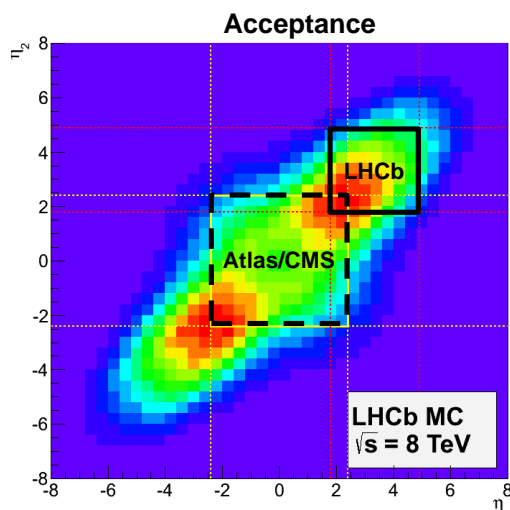
Status of The LHCb Upgrade

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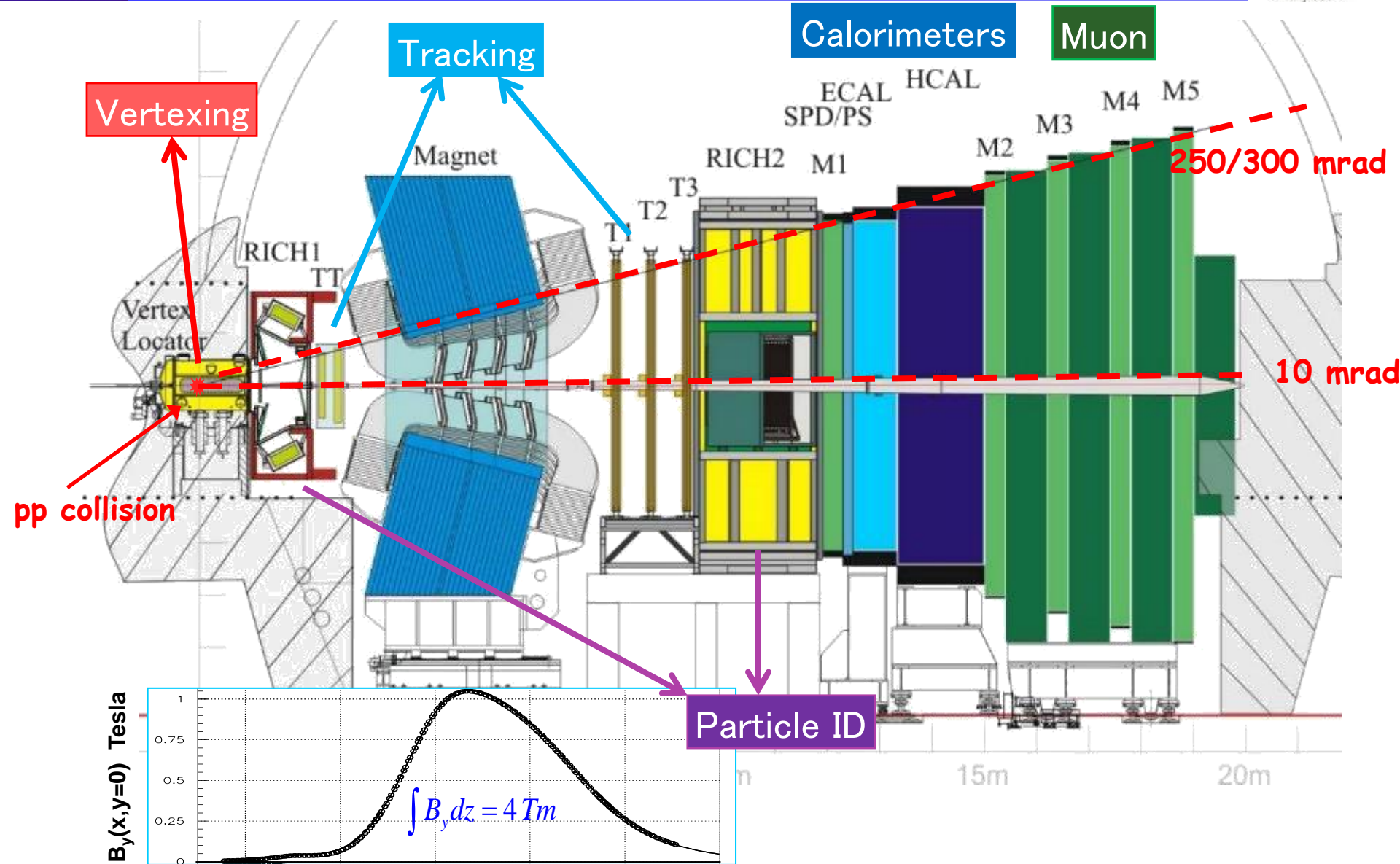


- ❖ The LHCb detector covers the forward region. This is driven by the physics goals: to study b & c sectors on CP-violation, rare decays, & search for new physics.
- ❖ Correlated production of $b\bar{b} \Rightarrow$ flavor tagging. Boost in $Z \Rightarrow$ decay length measurement.
- ❖ It provides precision measurements:
 - Spatial resolution $\sim 4 \mu\text{m}$ @ vertex detector.
 - $\Delta p/p = 0.4\%$ at 5 GeV/c, 0.6% at 100 GeV/c.
 - Impact parameter resolution $\sim 20 \mu\text{m}$ for high-pT tracks.
 - Decay time resolution 45 fs (e.g. $B_s \rightarrow J/\psi \phi$).
 - Excellent particle identification.



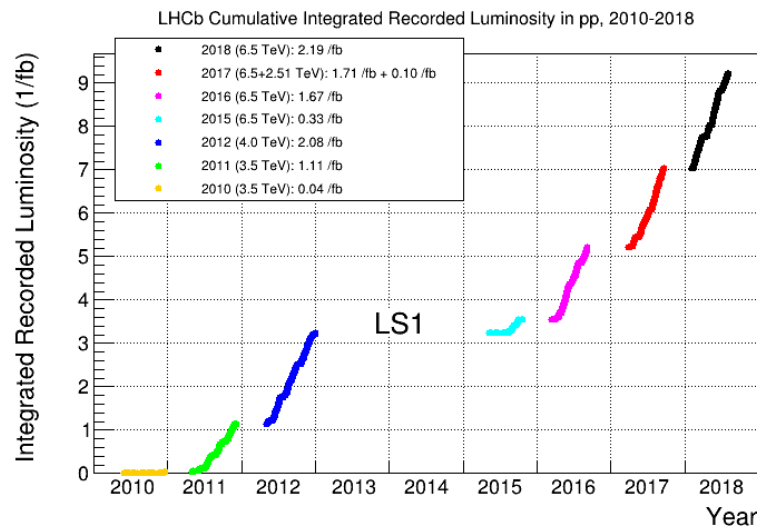
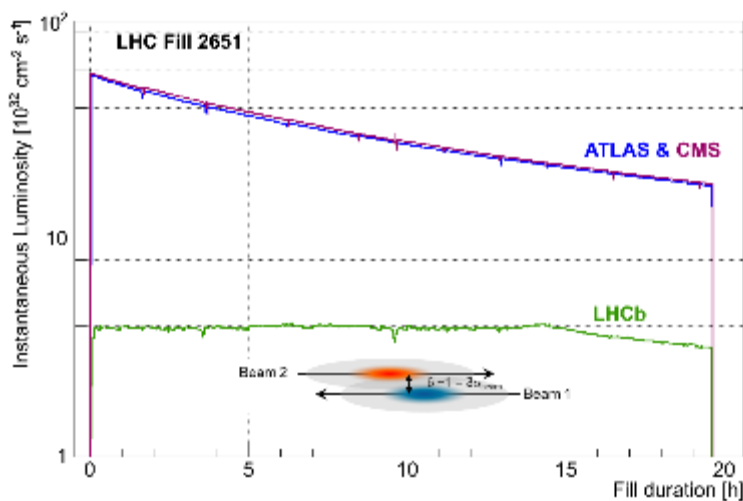
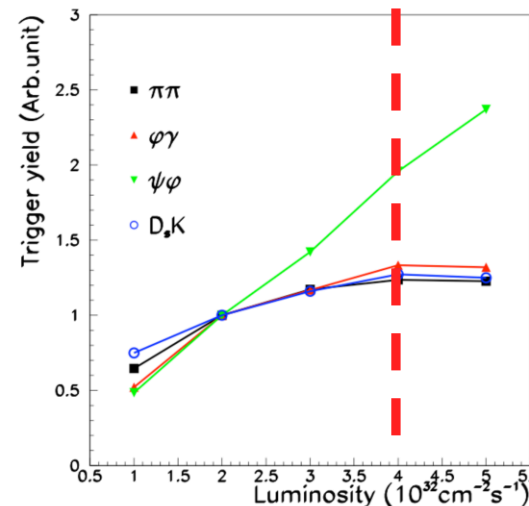


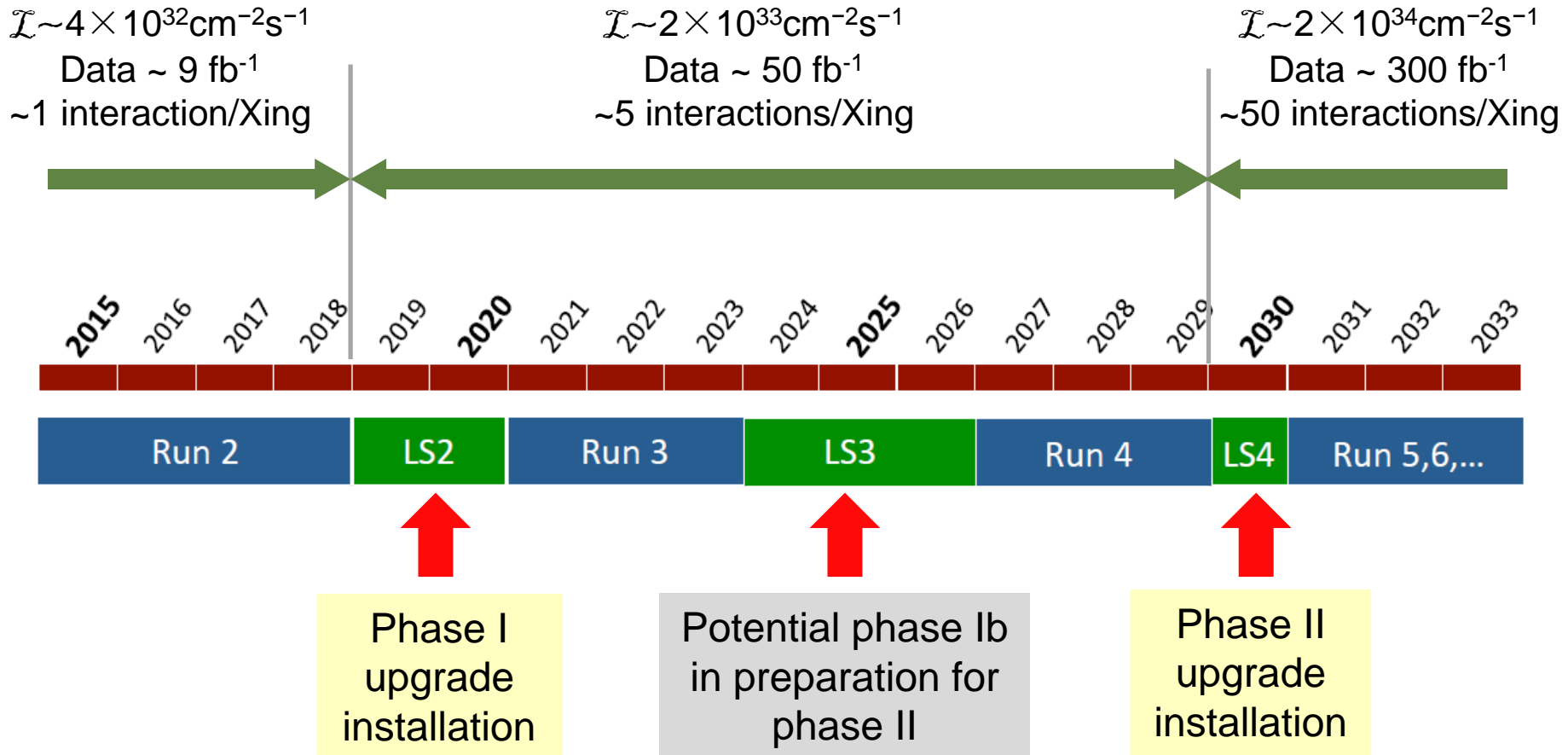
The LHCb Detector Before LS2

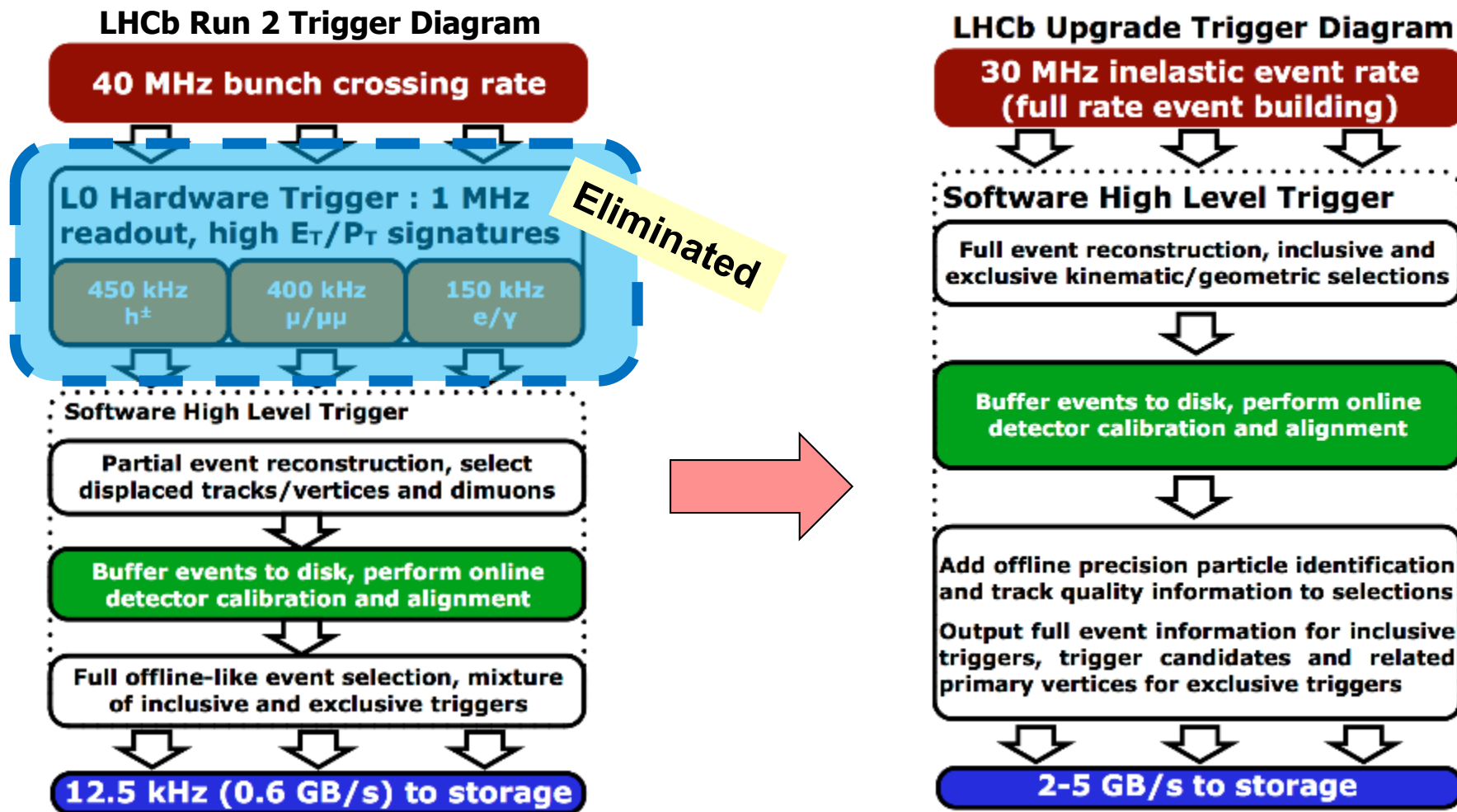




- ❑ LHCb records 1–2 fb⁻¹/year, 9.2 fb⁻¹ in Runs 1 & 2.
- ❑ It did not explore the full capability that the LHC can deliver, but operated at a reduced luminosity.
 - Overall performance degrades with higher occupancy.
 - Lower efficiency for hadronic decays at higher luminosity due to the hardware trigger.
 - Limited radiation hardness of the trackers.
- ❑ Luminosity leveling within each run.



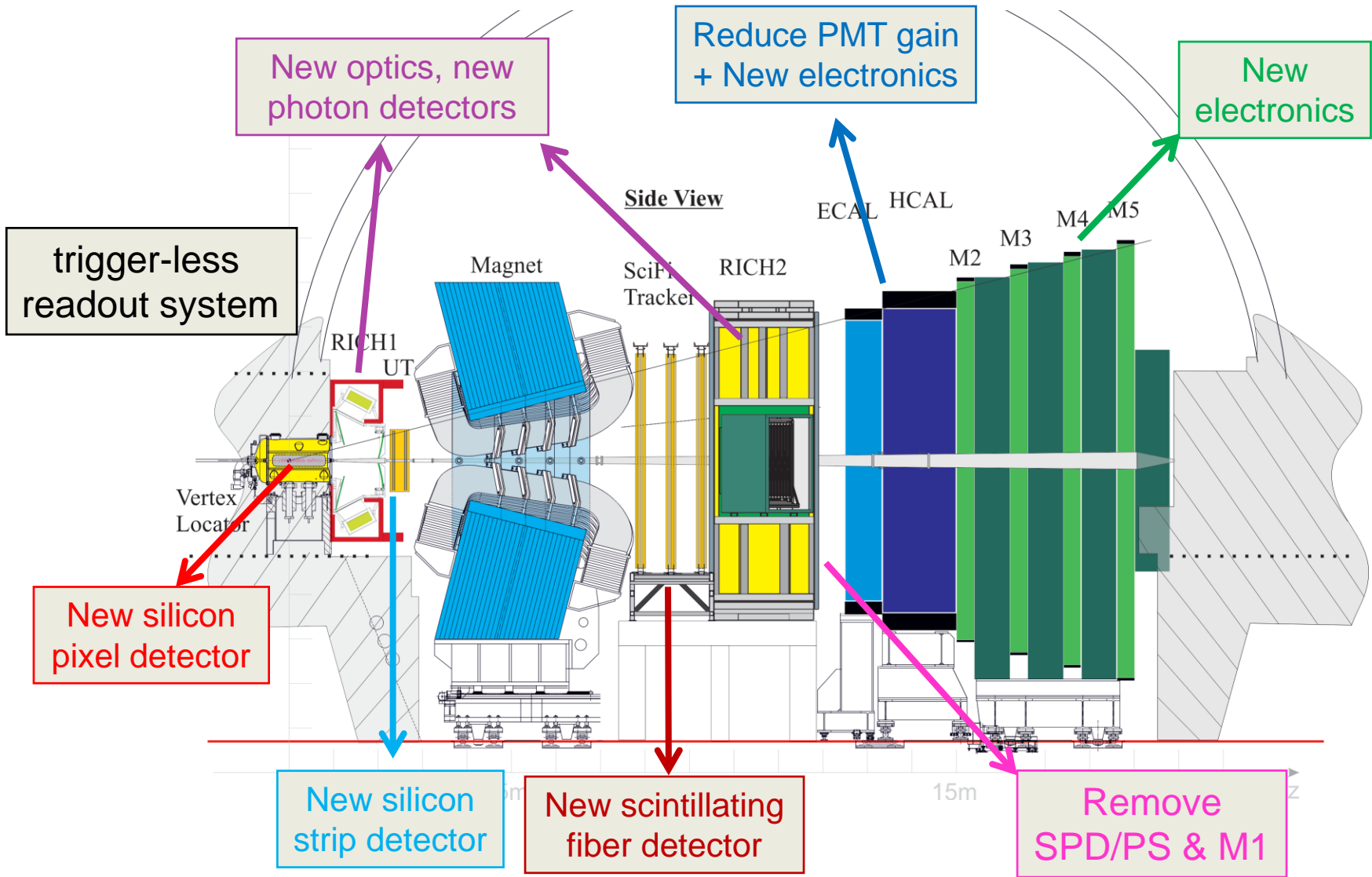


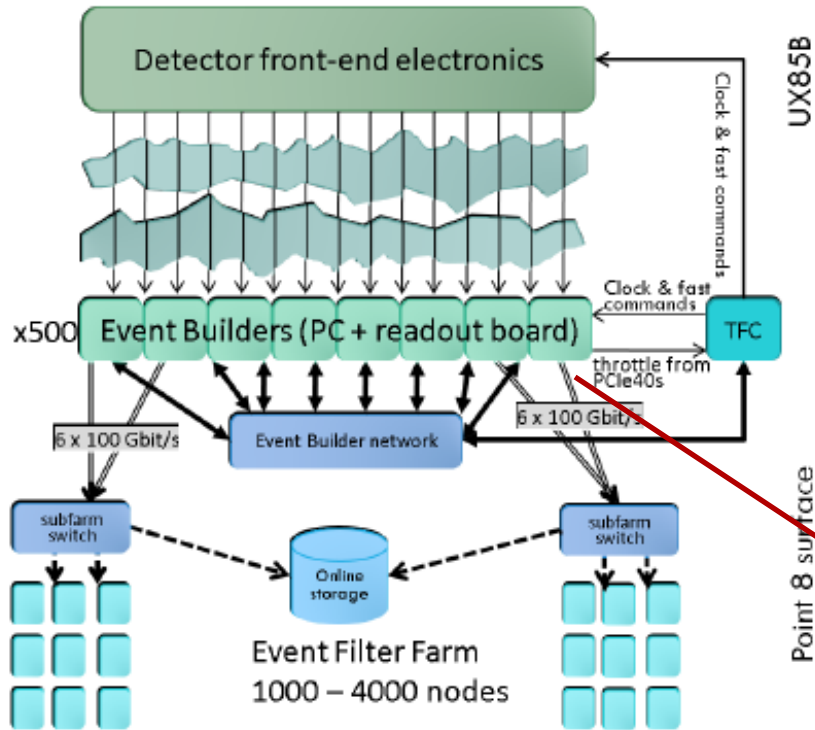




- ❖ Remove the L0 hardware trigger.
- ❖ A flexible software trigger is performed entirely on a CPU farm.
- ❖ Information from all sub-detectors are available to enhance the trigger decision and maximize the signal efficiency at higher luminosity.
- ❖ All detectors be read out @ 40 MHz
 - Replace FE electronics of all detectors.
 - A new read out network to cope with multi-TB/s data stream.
- ❖ Detectors work at a higher luminosity
 - High granularity for increased multiplicities.
 - Radiation resilience.

The Phase-I Upgraded Detectors





UX85B

Point 8 surface

- A computer farm on the surface.
- Connect to FE via ~300m optical fibers.
- GBTx, GBT-SCA, VTRx, VTTx etc are commonly used at the FE.



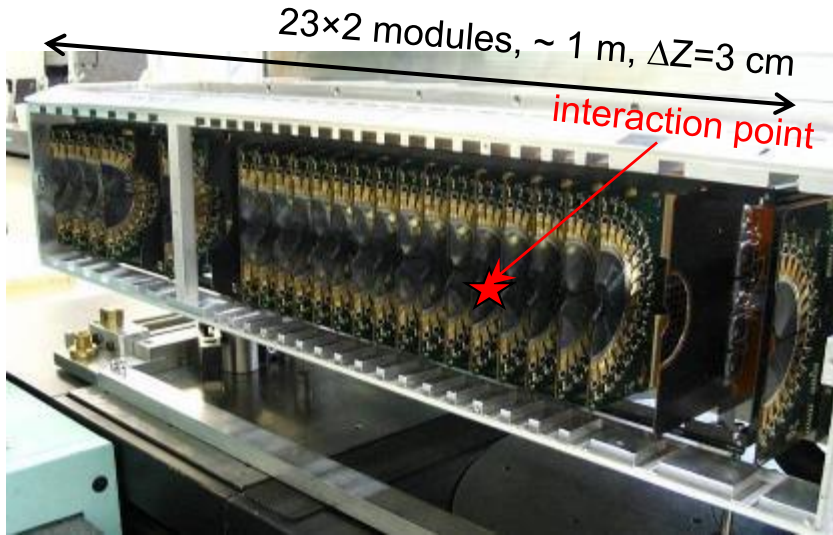
- A PCIe40 module for detector readout, ECS & TFC, common to all sub-detectors.
- The production (~700 cards) is nearly done.



Total 6 modules: 2 already running, 2 under commissioning, 2 delivered.

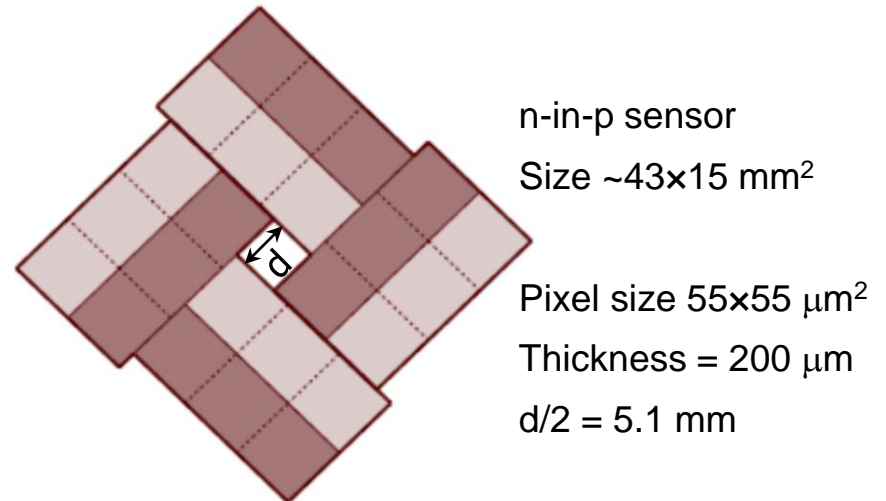
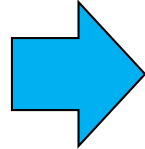
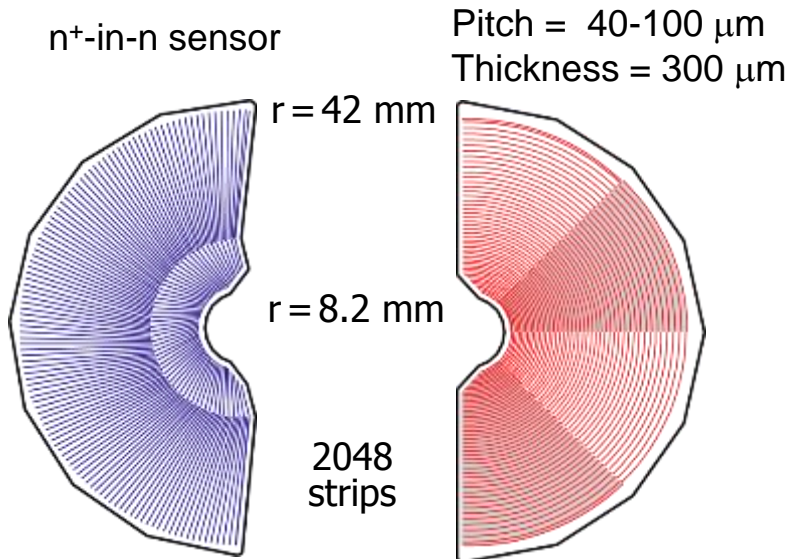


All long optical fiber trunks between FE & the data center are pulled, connected and tested (# ~19,000)



- ❖ Similar overall geometry as the old one, total 26×2 modules, 2.5 cm gaps in Z. Two halves are retractable.
- ❖ Strip detector ⇒ pixel detector.
- ❖ VeloPix readout ASIC, 256 x 256 pixel matrix, binary readout at 40 MHz.
- ❖ Significantly increased number of channels: ~0.2 M ⇒ ~40 M
- ❖ More radiation hard sensor:

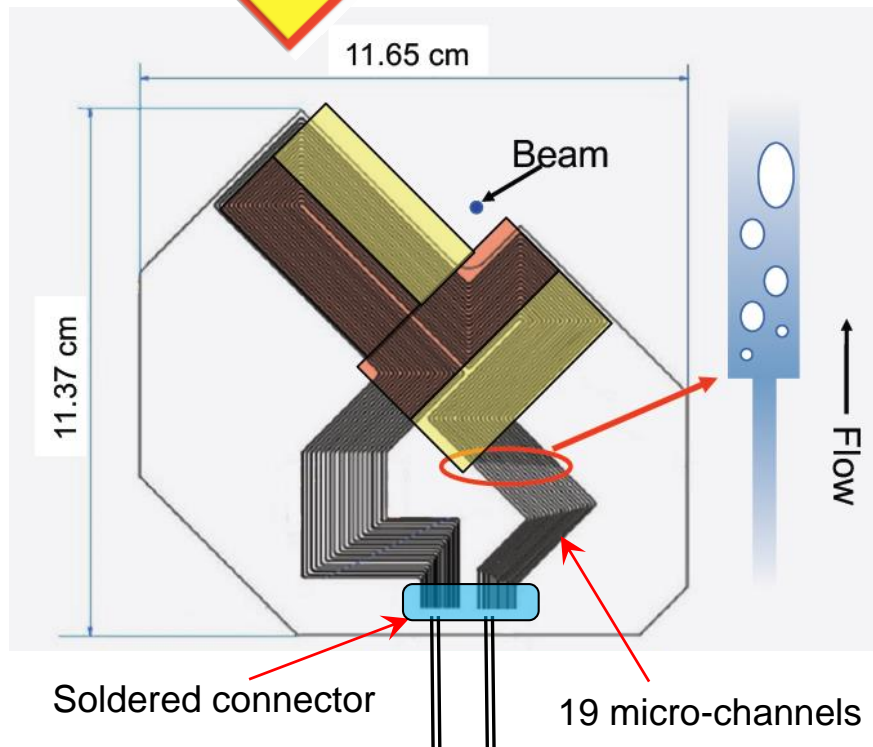
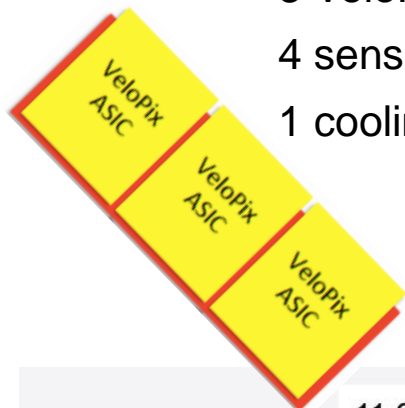
$$\Phi_{\max} \sim 7 \times 10^{14} \Rightarrow 8 \times 10^{15} n_{eq} \text{ cm}^{-2}$$



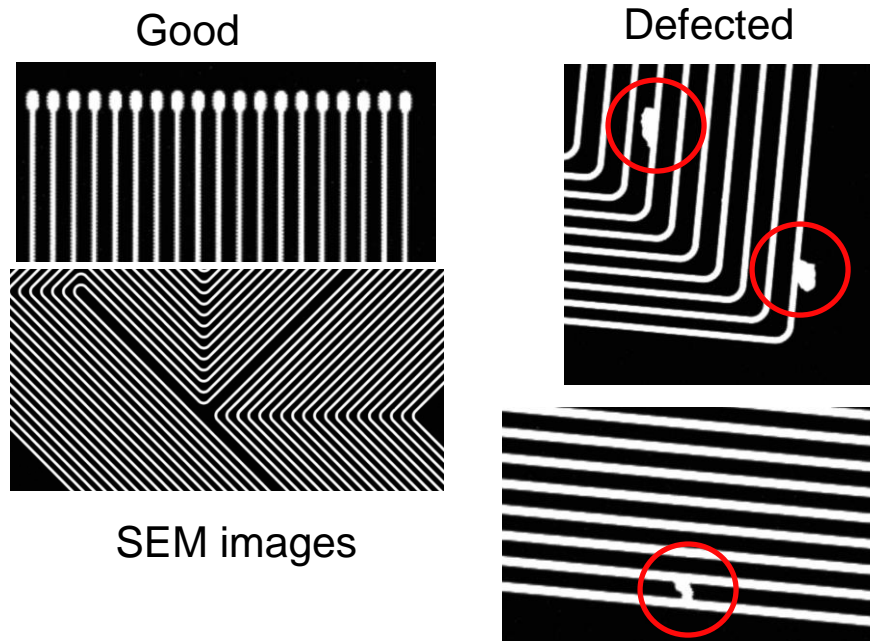
VELO Cooling Substrate



- 3 VeloPix ASICs / sensor
- 4 sensors / module
- 1 cooling substrate / module

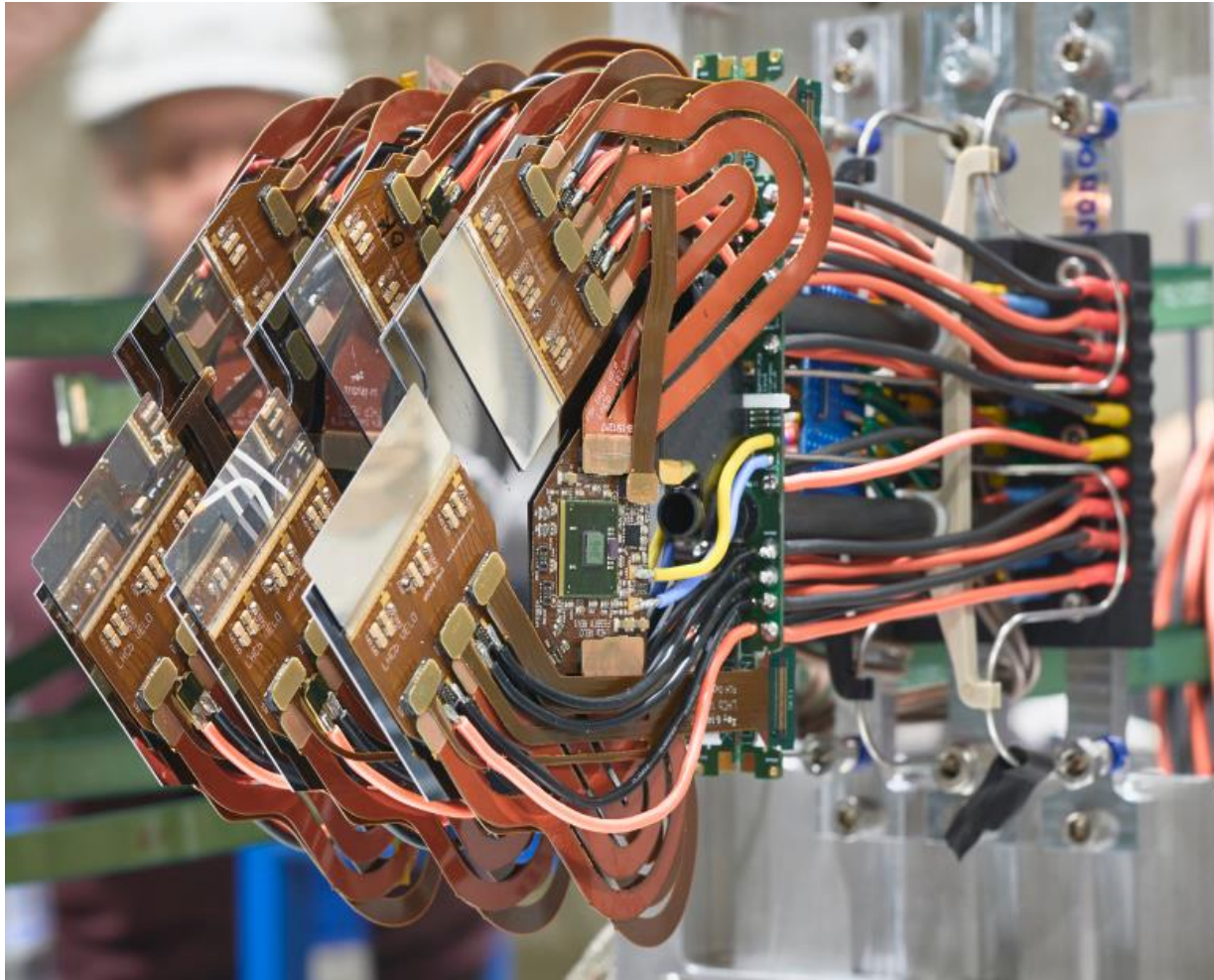


- VELO uses evaporative CO₂ cooling. So that the silicon sensor operates <-20°C.
- 120×200 μm² micro channels are etched in 500 μm silicon substrate, 60×60 μm² at the entrance for stability.
- It is a real challenge. But enough good quality substrates have been produced.





3 prototype modules at a testbeam



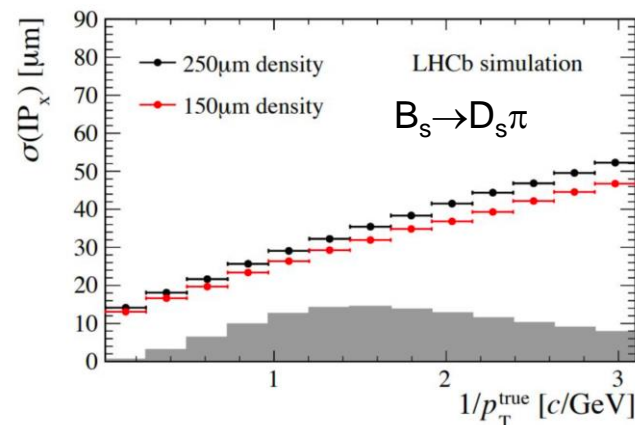
Need 52 modules in the system.

7 modules were produced as of mid of September.

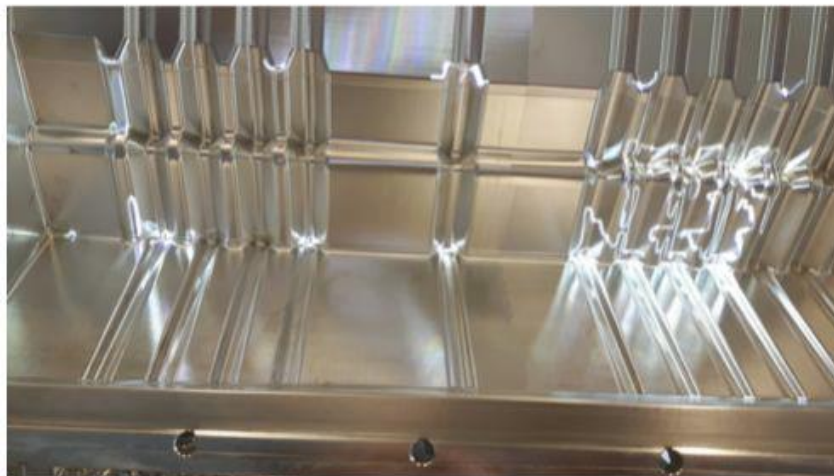
More are being produced.



- RF shields separate the beam vacuum and the detector volume (~10 mbar difference).
- The thickness significantly affects the performance.
- The RF shields were milled from AlMg3 alloy blocks, to reach ~250 μm at tips of the VELO module.
- Chemical etching was proved to work properly (NaOH solution, in steps of 20-50 μm).
- The proposal to thin the RF shield to 150 μm was approved by the TB this September.



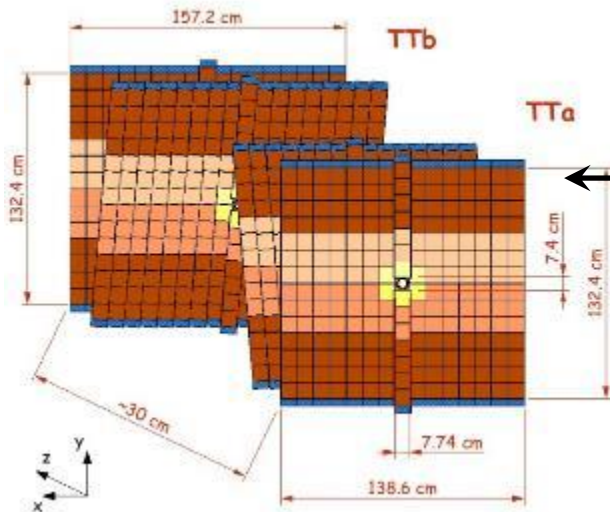
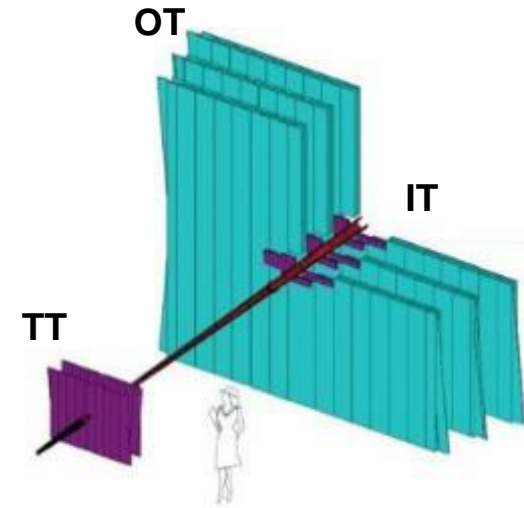
Impact parameter improves by 10%, if thickness is reduced from 250 μm to 150 μm.



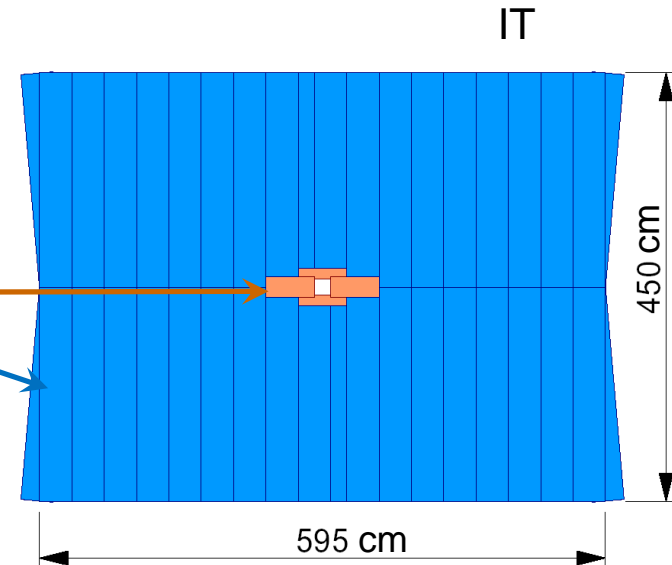
The Tracking Stations Before Upgrade

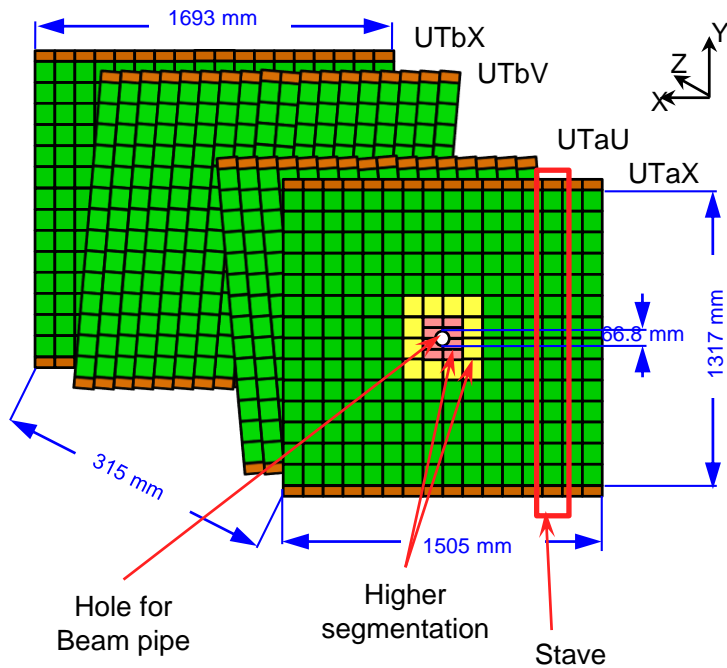


- ❖ The tracking stations consist of 4 planes TT before the magnet, and 3x4 planes of IT & OT after the magnet.
- ❖ Four planes (x,u,v,x) at $(0^\circ, +5^\circ, -5^\circ, 0^\circ)$, provide stereo measurements, with horizontal precision.
- ❖ TT & IT are silicon strip detectors, read out by Beetle ASICs outside active area.
- ❖ OT is made of Kapton/Al straw drift tubes $d=5$ mm, with $Ar+CO_2+O_2$ gas, providing ~ 200 μm resolution.



Trigger Tracker (TT)
 Inner Tracker (IT)
 Outer Tracker (OT)

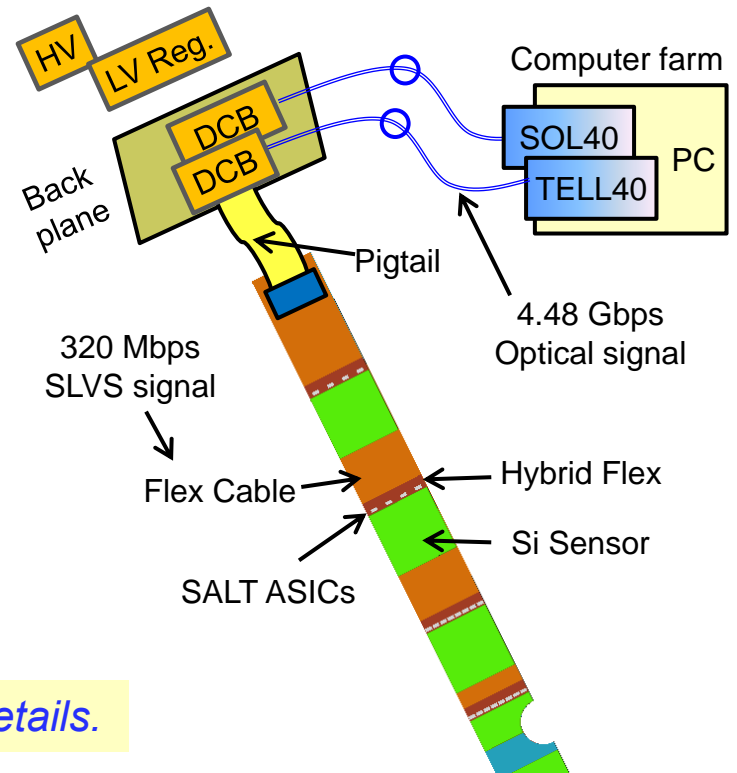




- ❑ Read out at 40 MHz by custom SALT ASICs in the sensor proximity.
- ❑ Digital events are packed in ASIC, sent out at the end of detector via optical fibers.

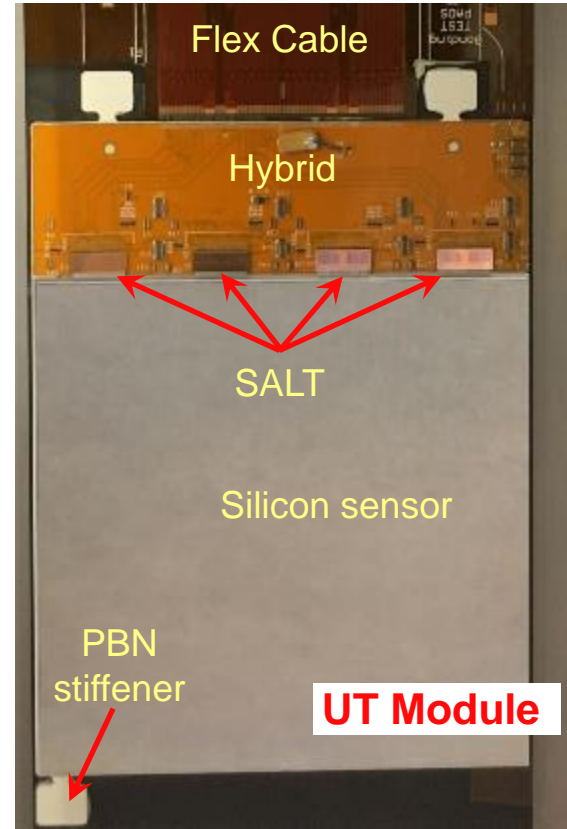
See Yiming Li's presentation for more details.

- ❑ Similar geometric configuration as TT.
- ❑ Improved coverage and segmentation.
- ❑ Sensor is more radiation resilience, $\Phi_{\max} \sim 5 \times 10^{14} n_{eq} \text{cm}^{-2}$.

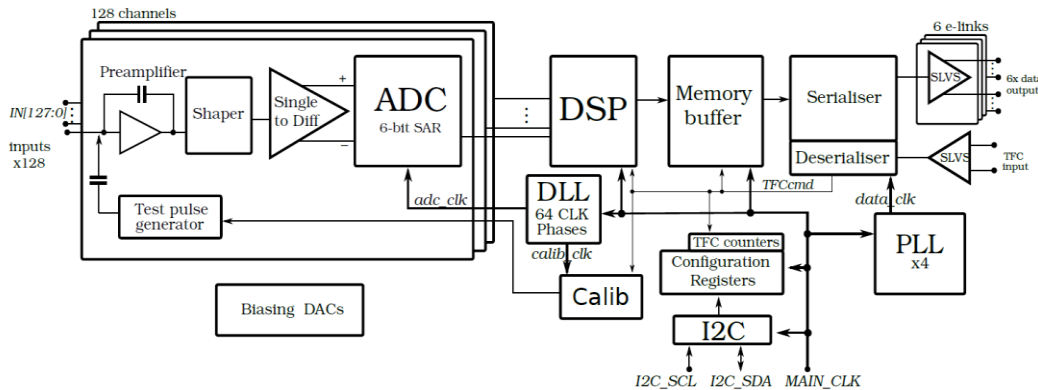




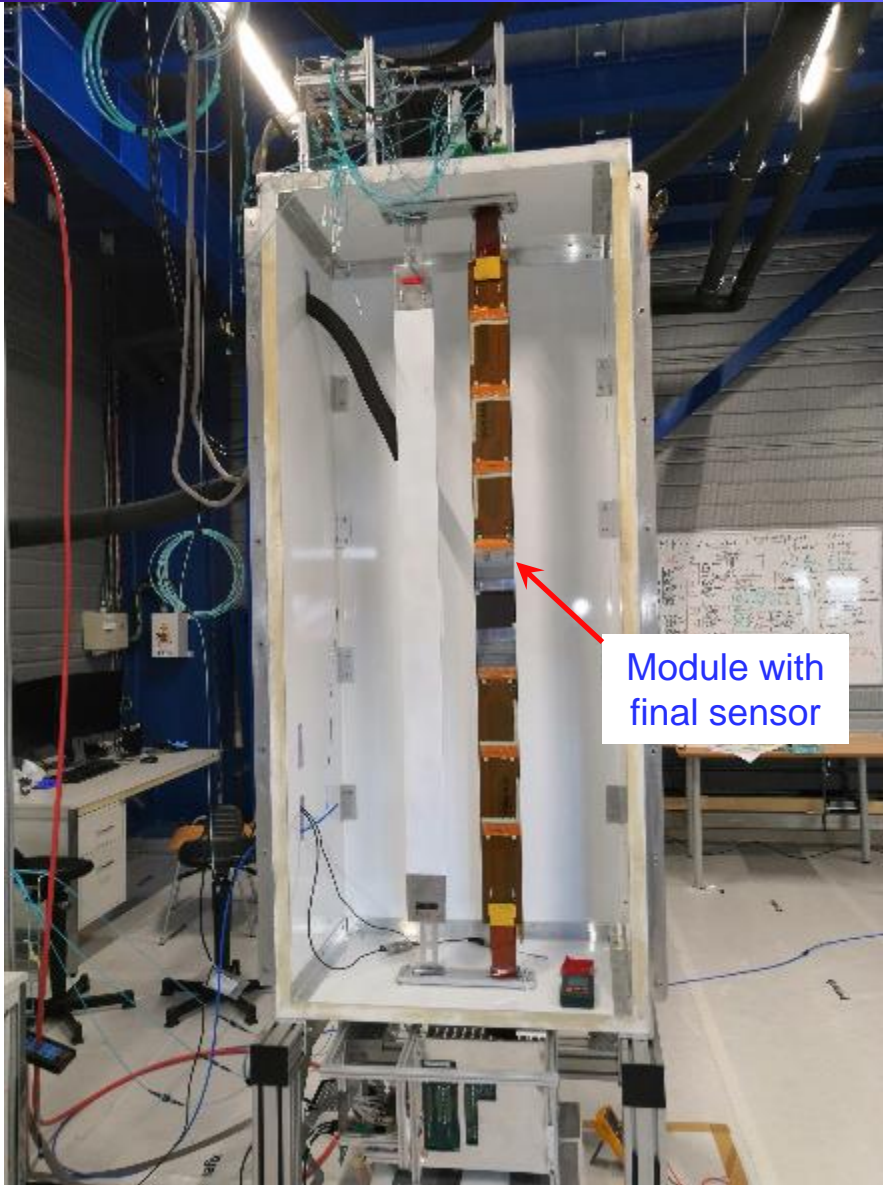
- ❑ Silicon sensor p-in-n, n-in-p types, thickness 320, 250 μm , strip pitch 187.5, 93.5 μm , length $\sim 10, 5$ cm.
- ❑ The FE readout ASIC, SALT, is custom designed: TSMC 130 nm technology, 6-bit SAR ADC, input signal of both polarities, a peaking time $\sim 25\text{ns}$, quick return, SLVS digital output.
- ❑ SALT still needs to settle an issue, especially for modules in the high radiation central area.



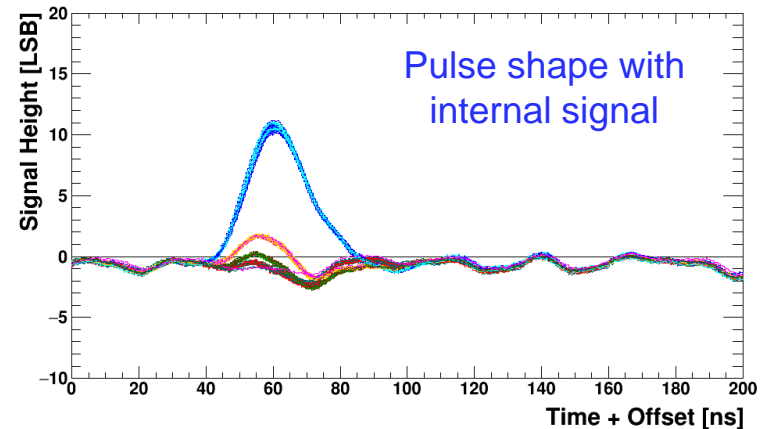
SALT



- ❑ Module production for the low radiation area started.
- ❑ Total 968 modules in the system.

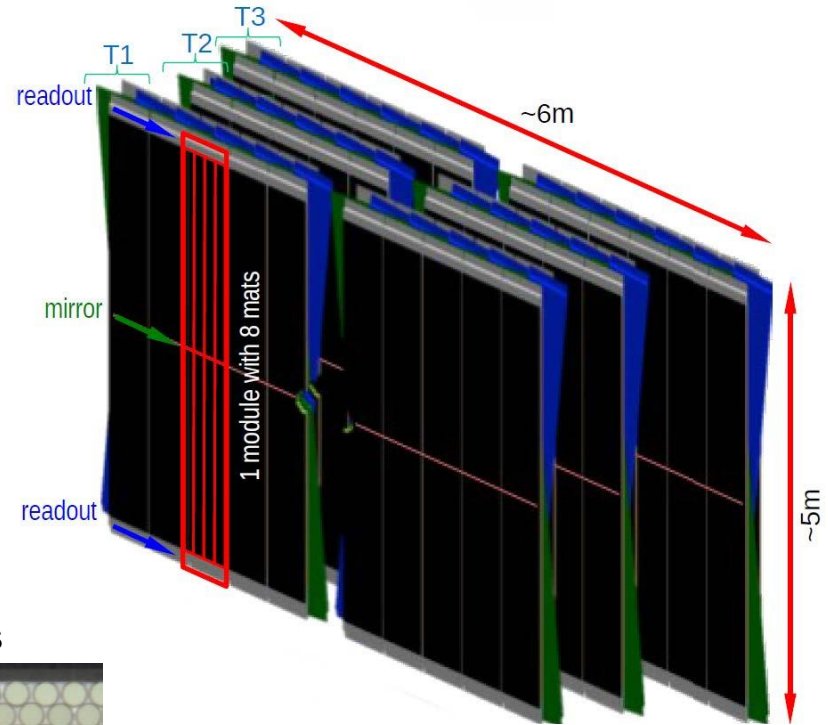


- ❑ A UT slice system was set up at CERN, including a prototype stave of all 14 modules but only 1 module has sensor.
- ❑ The readout electronics are all very close to the final version.
- ❑ Performance of the module meets the design goal.
- ❑ Stave production for the low radiation area started.
- ❑ The 1st stave will be mounted this Nov.

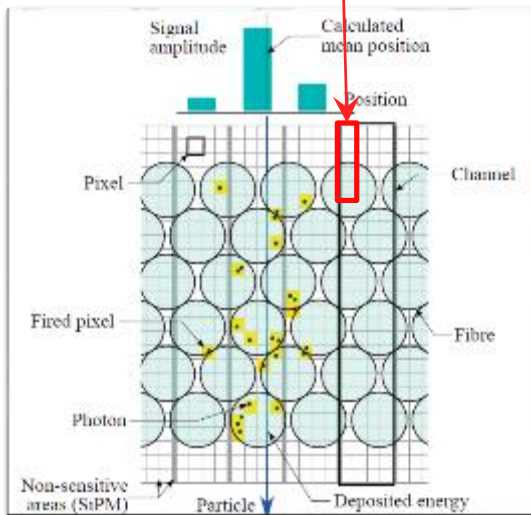




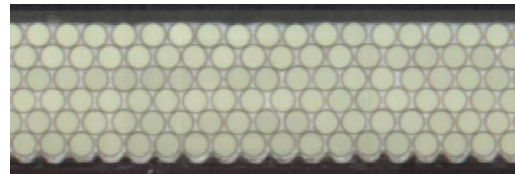
- Tracking stations are replaced by 3-station (12-plane) scintillation fiber detector.
- Read out with arrays 4096 SiPMs (-40°C) + custom made PACIFIC ASICs. In total ~ 0.5 M readout channels.
- Spatial resolution better than 100 μm in X.
- Single hit efficiency ~99%.



1 SiPM Channel



6 layers staggered
 $\text{\O}250 \mu\text{m}$ fiber mats

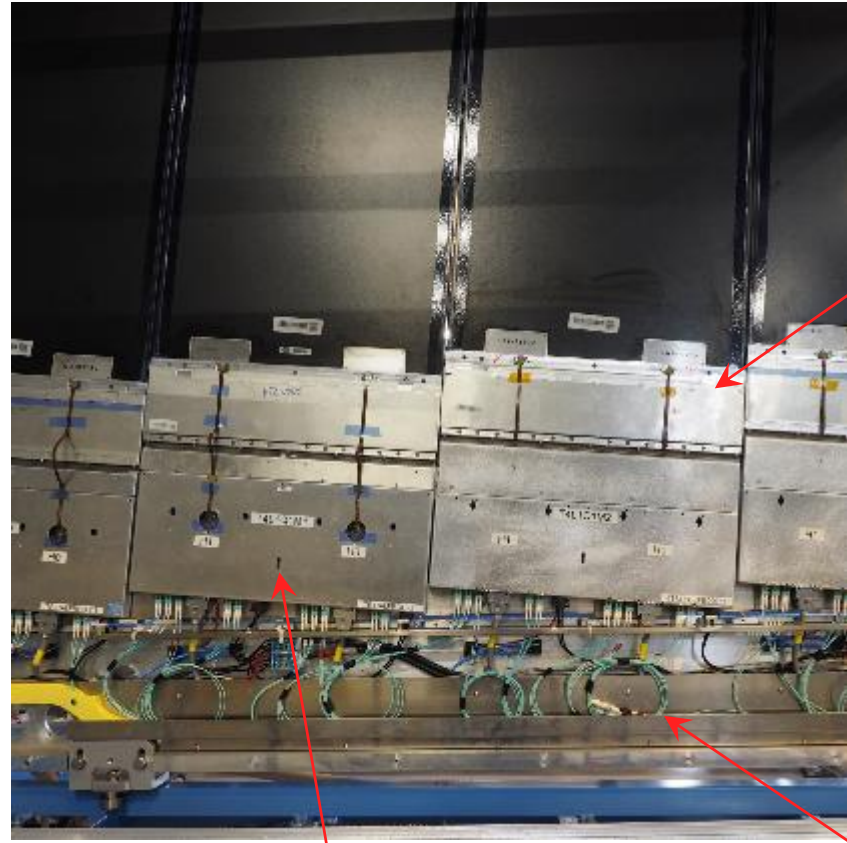


128-ch SiPM Array

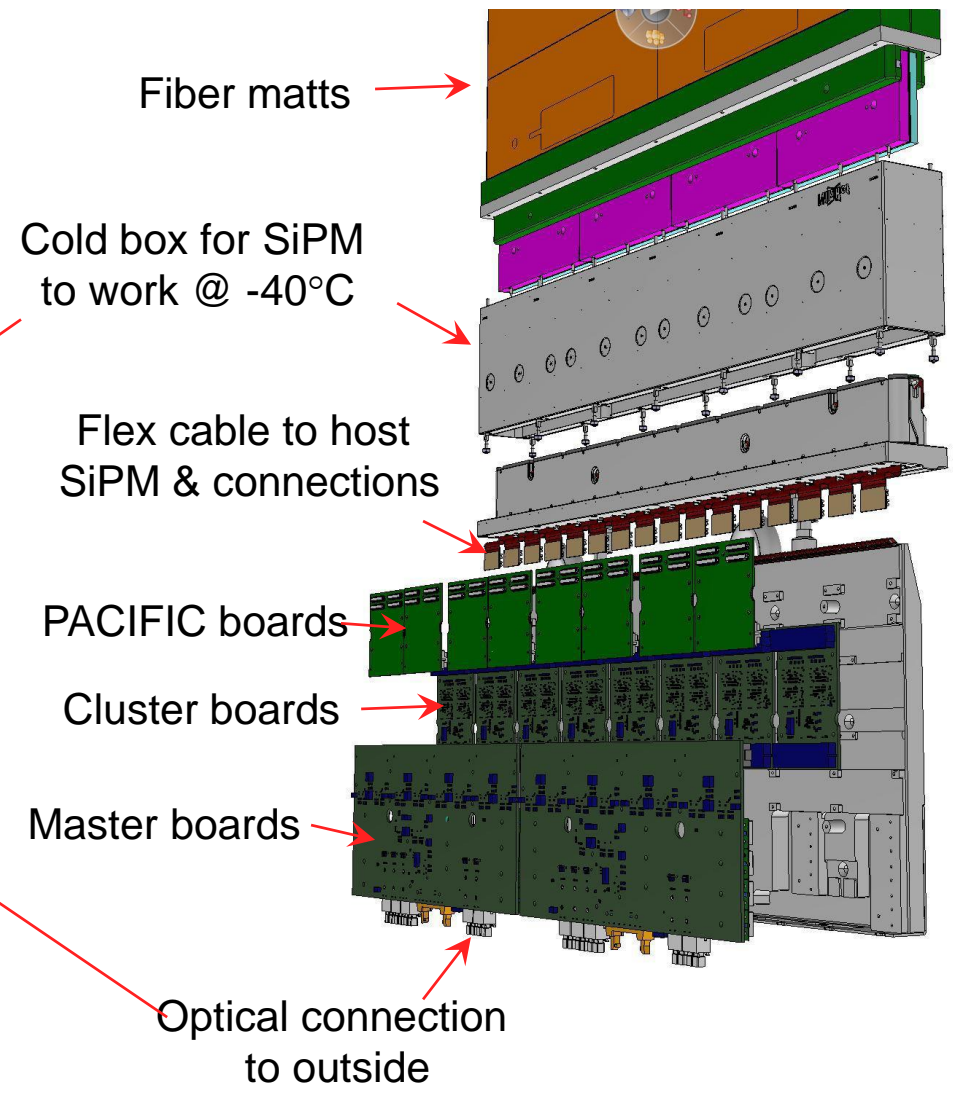


3 stations \times 4 planes (X,U,V,X).
10 (or 12) modules / plane
8 (4×2) mats / module.

See Ming Zeng's presentation for more details



Electronics boards inside FE boxes

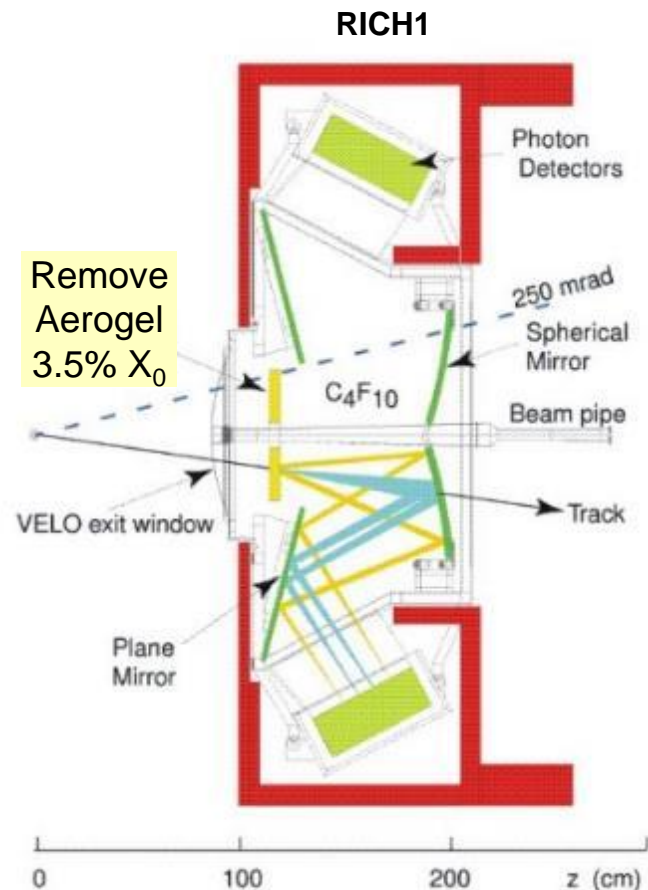
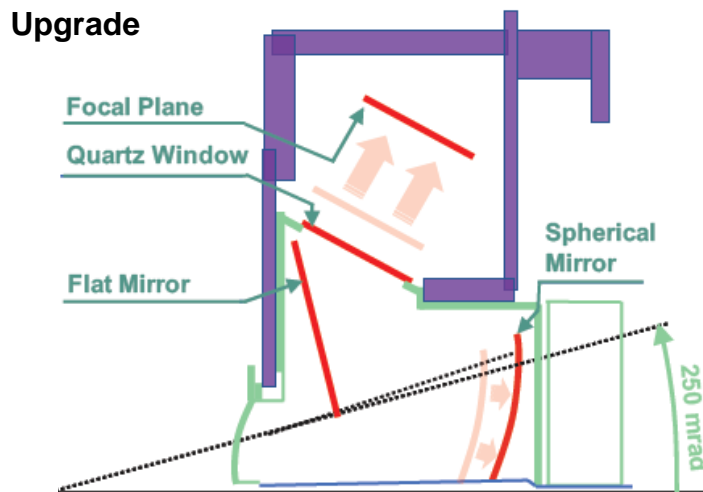


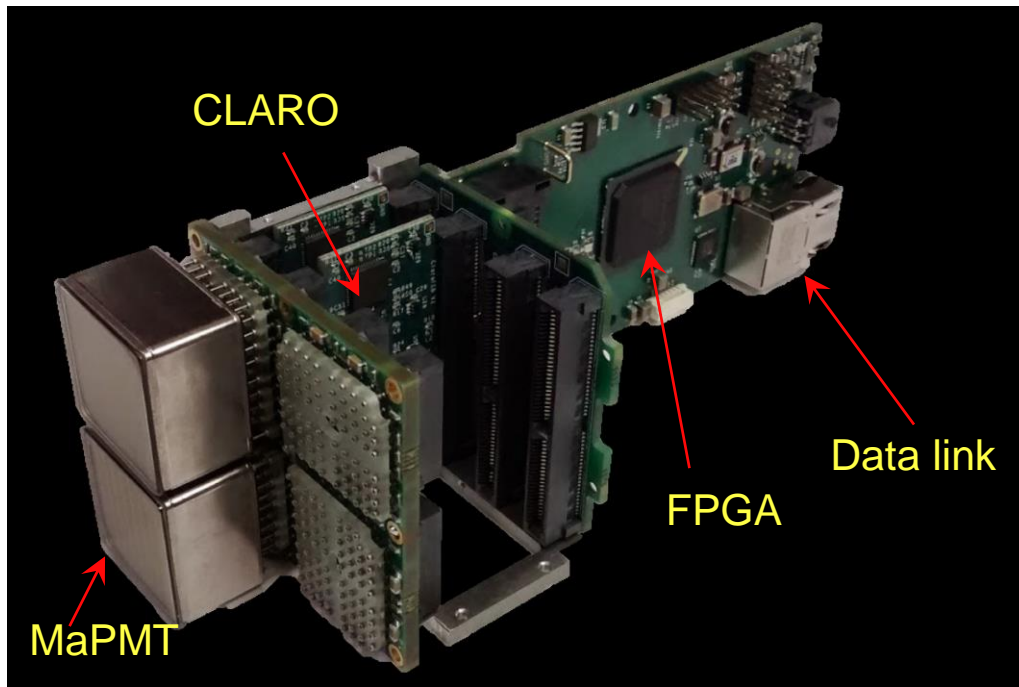


- ❑ All Modules are produced. As of September some of the modules were equipped with cold boxes. Some are already mounted on the C-frames at CERN.
- ❑ PACIFIC boards & cluster boards are ready. ~1/3 of master boards are done.



- ❑ Two RICH detectors for track PID:
 - RICH1 (aerogel + C_4F_{10}) for $2 < P < 60$ GeV.
 - RICH2 (CF_4) for $15 < P < 100$ GeV.
- ❑ Cherenkov photons are detected by HPDs.
- ❑ Remove aerogel radiator in RICH1.
- ❑ Focal plane and optics are modified to increase the size of Cherenkov rings.
- ❑ Replace HPDs with MaPMTs of size 1" and 2" squares, 8×8 matrix.



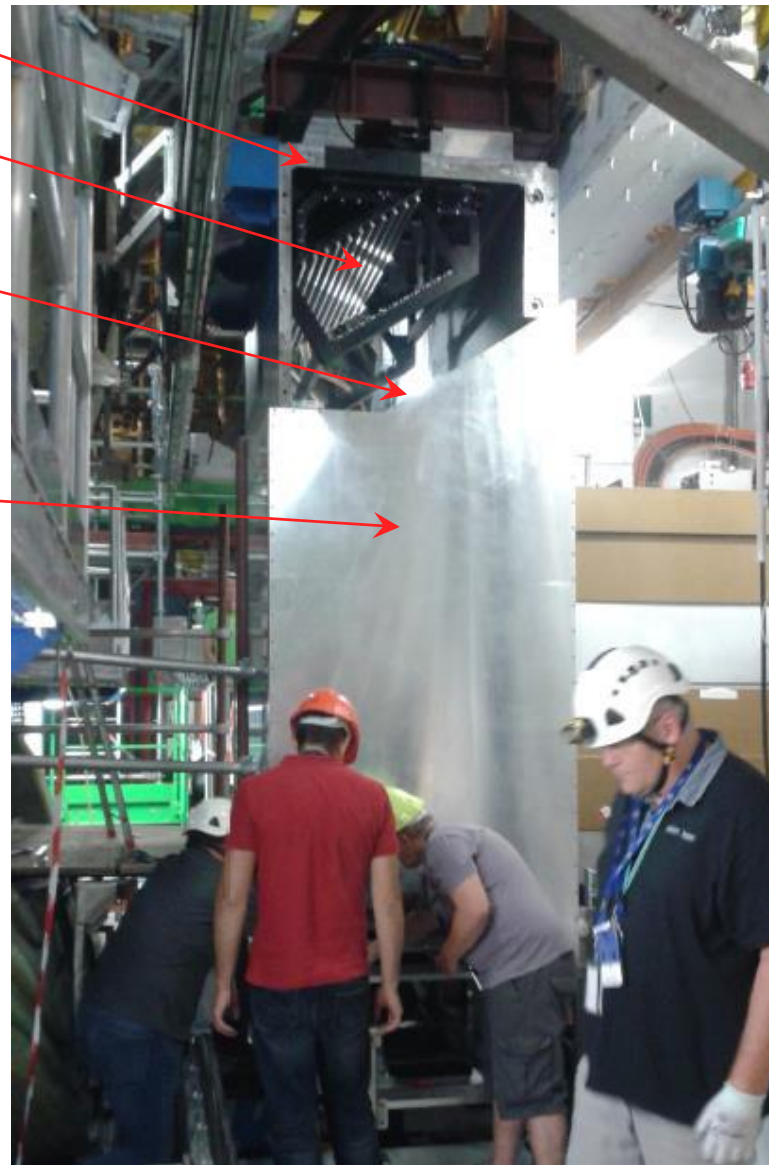


- MaPMT production finished.
- Signal processed by CLARO ASICs: custom made 8-channel amplifier/discriminator.
- Photo detector data board production on going, all other boards are ready.
- Photon detector column construction started.



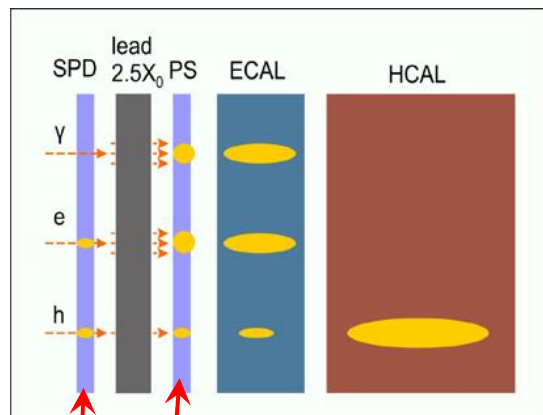


- Magnetic shielding
- Photon detector upper chassis
- Quartz window for photon exit
(not seen from this angle)
- Gas enclosure



- All mechanical components are in place, including mirrors and windows.
- Assembly started at CERN.
- The upper quartz window has a crack, which will cause some delay.

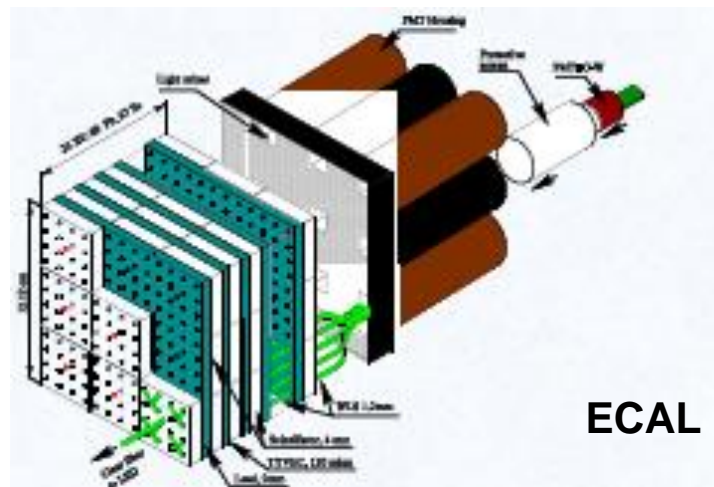
Calorimeter Upgrade



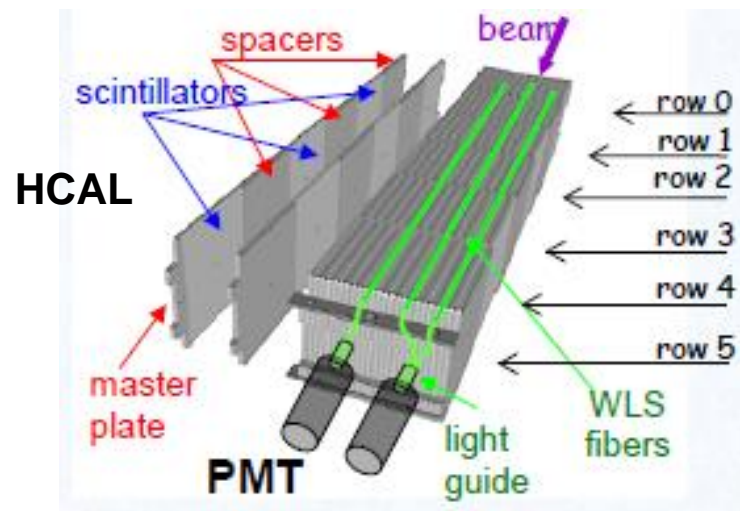
PS (Pre-shower)

SPD (scint. pad detector)

- Scintillation/WLS technology, PMT to detect photon.
 - Provide L0 trigger on high E_T $e/\gamma/h$.
 - e/γ /hadron ID, energy & position.
 - ECAL: Pb + scintillator, HCAL: Fe + scintillating tiles.
 - Fine segmentation at the center.
- Remove SPD & PS; HCAL will be removed later.
 - Reduce PMT gain by factor of 5, to reduce aging.
 - New FE electronics for 40 MHz readout.



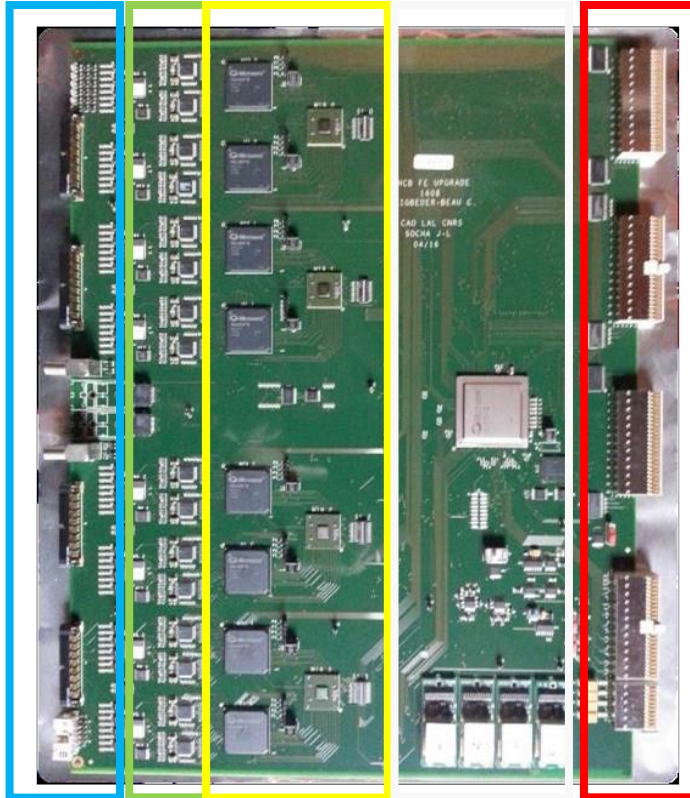
ECAL



HCAL



CALO FEB



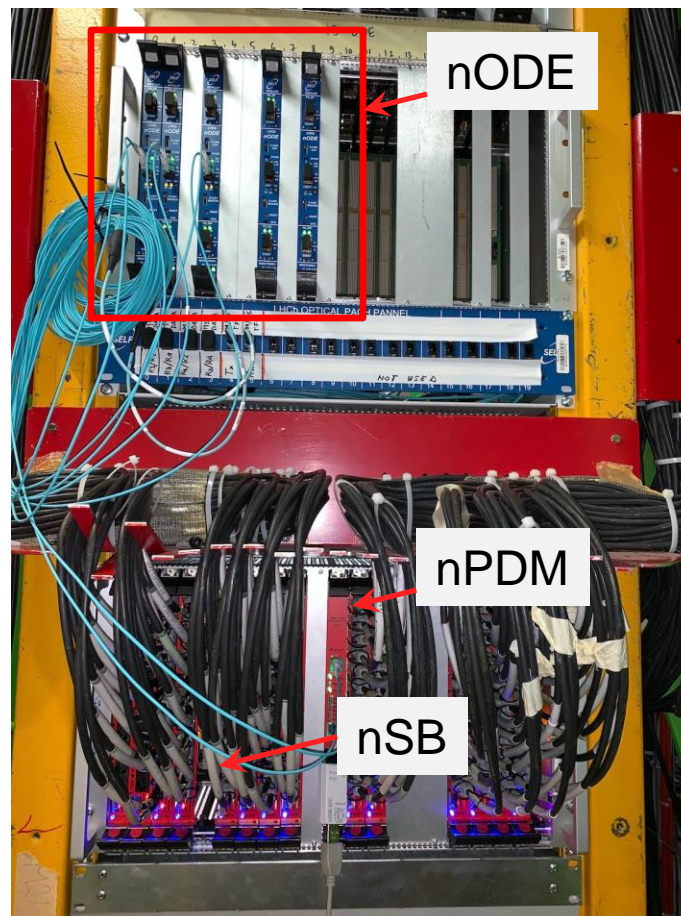
Front panel
Analog input
Analog part
Digital part
Digital part
Ctrl and
ECS.Regulators
Interconnection
Power

- ❖ FE boards & Control boards: preproduction are under test, production to start soon.
- ❖ HV/Monitor/Calib boards are ready.



- Total 5 stations: M1-M5.
- Triple-GEM detector @ the center of M1 for high hit rates. The rest are MWPCs, higher granularity close to beam.
- Gives $\delta p/p \sim 20\%$ for L0 trigger.
- Muon ID cut of ~ 6 GeV.

- Remove M1 (upstream of SPD/PS),
- Add shield in front of M2 at the center to reduce the rate, which is delivered.
- New readout electronics. Preproduction boards are deployed and OK'ed. The full production finishes next February.



Possibilities In The Phase II Upgrade



$\mathcal{L} \sim 2 \times 10^{34} \text{cm}^{-2}\text{s}^{-1}$
 Data $\sim 300 \text{fb}^{-1}$

New Vertex
 Detector
 (4D?)

Add
 Magnet Station

New ECAL
 Technology ?

Remove
 HCAL

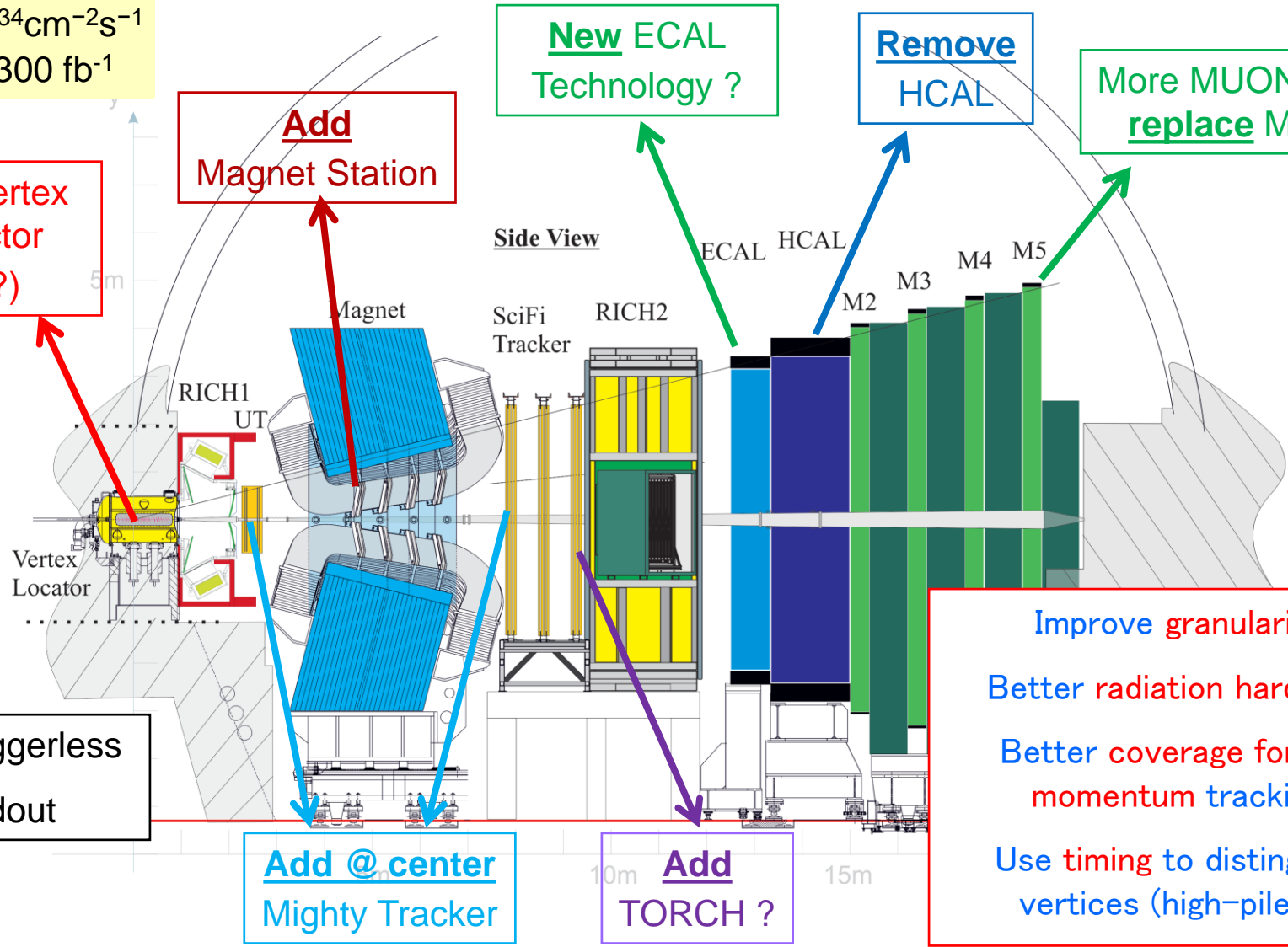
More MUON filter +
replace MWPC

Keep triggerless
 readout

Add @ center
 Mighty Tracker

Add
 TORCH ?

Improve granularity
 Better radiation hardness
 Better coverage for low
 momentum tracking
 Use timing to distinguish
 vertices (high-pileup)





Observable	Current LHCb	LHCb 2025	Belle II	Upgrade II	ATLAS & CMS
EW Penguins					
$R_K (1 < q^2 < 6 \text{ GeV}^2 c^4)$	0.1 [274]	0.025	0.036	0.007	–
$R_{K^*} (1 < q^2 < 6 \text{ GeV}^2 c^4)$	0.1 [275]	0.031	0.032	0.008	–
$R_\phi, R_{\rho K}, R_\pi$	–	0.08, 0.06, 0.18	–	0.02, 0.02, 0.05	–
CKM tests					
γ , with $B_s^0 \rightarrow D_s^+ K^-$	$(\begin{smallmatrix} +17 \\ -22 \end{smallmatrix})^\circ$ [136]	4°	–	1°	–
γ , all modes	$(\begin{smallmatrix} +5.0 \\ -5.8 \end{smallmatrix})^\circ$ [167]	1.5°	1.5°	0.35°	–
$\sin 2\beta$, with $B^0 \rightarrow J/\psi K_S^0$	0.04 [609]	0.011	0.005	0.003	–
ϕ_s , with $B_s^0 \rightarrow J/\psi \phi$	49 mrad [44]	14 mrad	–	4 mrad	22 mrad [610]
ϕ_s , with $B_s^0 \rightarrow D_s^+ D_s^-$	170 mrad [49]	35 mrad	–	9 mrad	–
ϕ_s^{tagged} , with $B_s^0 \rightarrow \phi \phi$	154 mrad [94]	39 mrad	–	11 mrad	Under study [611]
α_{SI}^s	33×10^{-4} [211]	10×10^{-4}	–	3×10^{-4}	–
$ V_{ub} / V_{cb} $	6% [201]	3%	1%	1%	–
$B_s^0, B^0 \rightarrow \mu^+ \mu^-$					
$\mathcal{B}(B^0 \rightarrow \mu^+ \mu^-)/\mathcal{B}(B_s^0 \rightarrow \mu^+ \mu^-)$	90% [264]	34%	–	10%	21% [612]
$\tau_{B_s^0 \rightarrow \mu^+ \mu^-}$	22% [264]	8%	–	2%	–
$S_{\mu\mu}$	–	–	–	0.2	–
$b \rightarrow c \ell^- \bar{\nu}_\ell$ LUV studies					
$R(D^*)$	0.026 [215, 217]	0.0072	0.005	0.002	–
$R(J/\psi)$	0.24 [220]	0.071	–	0.02	–
Charm					
$\Delta A_{CP}(KK - \pi\pi)$	8.5×10^{-4} [613]	1.7×10^{-4}	5.4×10^{-4}	3.0×10^{-5}	–
$A_\Gamma (\approx x \sin \phi)$	2.8×10^{-4} [240]	4.3×10^{-5}	3.5×10^{-4}	1.0×10^{-5}	–
$x \sin \phi$ from $D^0 \rightarrow K^+ \pi^-$	13×10^{-4} [228]	3.2×10^{-4}	4.6×10^{-4}	8.0×10^{-5}	–
$x \sin \phi$ from multibody decays	–	$(K3\pi) 4.0 \times 10^{-5}$	$(K_S^0 \pi\pi) 1.2 \times 10^{-4}$	$(K3\pi) 8.0 \times 10^{-6}$	–



- ❖ The LHCb detector is being upgraded to operate at $\mathcal{L} \sim 2 \times 10^{33} \text{cm}^{-2} \text{s}^{-1}$, and collect 50fb^{-1} data in the next ~ 10 years.
 - A trigger-less readout system, with online software trigger.
 - Tracking detectors (VELO, TT & IT/OT) are replaced with new detectors.
 - New optics and removal of aerogel in RICH1. New photon detectors and electronics in both RICH1 & RICH2.
 - New electronics in ECAL, HCAL, and Muon detectors.

- ❖ The upgrade proceeds reasonably well. There are problems to be solved. At this moment, we think there is no show stopper.

- ❖ Expect a major upgrade in LS4(~ 2030) for x10 higher luminosity, and a small upgrade in LS3(~ 2025). R&D work already started.